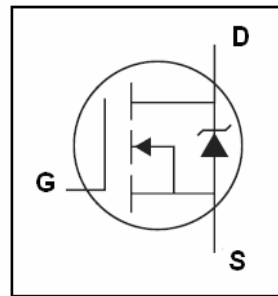


Features

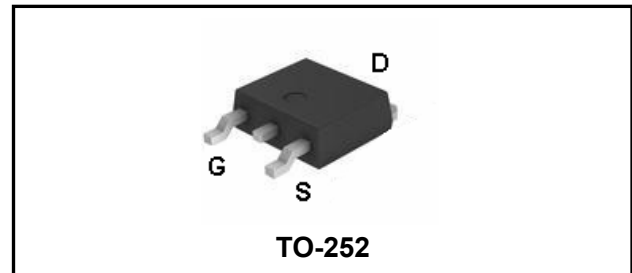
- ◆ Ron(typ.)=25 mΩ @V_{GS}=10V
- ◆ Ron(typ.)=35 mΩ @V_{GS}=4.5V
- ◆ Low On-Resistance
- ◆ 150°C Operating Temperature
- ◆ Fast Switching
- ◆ Lead-Free, RoHS Compliant



V _{DSS} = 30V
R _{DS(on)} = 25mΩ @ V _{GS} = 10V
R _{DS(on)} = 35mΩ @ V _{GS} = 4.5V
I _D = 19A

Description

VS3019AD designed by the trench processing techniques to achieve extremely low on-resistance. And fast switching speed and improved transfer effective. These features combine to make this design an extremely efficient and reliable device for variety of DC-DC applications.


Absolute Maximum Ratings

Symbol	Parameter		Rating	Unit
Common Ratings (T_c=25°C Unless Otherwise Noted)				
V _{GS}	Gate-Source Voltage		±12	V
V _{(BR)DSS}	Drain-Source Breakdown Voltage		30	V
T _J	Maximum Junction Temperature		150	°C
T _{STG}	Storage Temperature Range		-50 to 155	°C
I _S	Diode Continuous Forward Current	T _c = 25°C	19 ^①	A
Mounted on Large Heat Sink				
I _{DM}	Pulse Drain Current Tested	T _c = 25°C	76 ^①	A
I _D	Continuous Drain Current(V _{GS} =10V)	T _c = 25°C	19 ^①	A
		T _c = 70°C	12	
P _D	Maximum Power Dissipation	T _c = 25°C	40	W
R _{θJA}	Thermal Resistance Junction-Ambient		80	°C/W
Drain-Source Avalanche Ratings				
EAS	Avalanche Energy, Single Pulsed ③		13	mJ

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	30	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current (T _c =25°C)	V _{DS} =24V, V _{GS} =0V	--	--	1	μA
	Zero Gate Voltage Drain Current (T _c =125°C)	V _{DS} =24V, V _{GS} =0V	--	--	100	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±12V, V _{DS} =0V	--	--	±100	nA
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	0.5	0.9	1.5	V
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V, I _D =9A	--	25	35	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =4.5V, I _D =7A	--	35	45	mΩ
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
C _{iss}	Input Capacitance	V _{DS} =15V, V _{GS} =0V, f=1MHz	--	635	--	pF
C _{oss}	Output Capacitance		--	135	--	pF
C _{rss}	Reverse Transfer Capacitance		--	40	--	pF
Q _g	Total Gate Charge	V _{DS} =15V, I _D =5.8A, V _{GS} =4.5V	--	10.5	--	nC
Q _{gs}	Gate-Source Charge		--	1.6	--	nC
Q _{gd}	Gate-Drain Charge		--	2.7	--	nC
Switching Characteristics						
t _{d(on)}	Turn-on Delay Time	V _{DD} =15V, I _D =2.8A, R _G =3.3Ω, V _{GS} =4.5V	--	7.0	--	nS
t _r	Turn-on Rise Time		--	13	--	nS
t _{d(off)}	Turn-Off Delay Time		--	32	--	nS
t _f	Turn-Off Fall Time		--	3.5	--	nS
Source- Drain Diode Characteristics						
I _{SD}	Source-drain current(Body Diode)	T _c =25°C	--	--	12 ^①	A
V _{SD}	Forward on voltage	T _J =25°C, I _S =7A, V _{GS} =0V	--	0.8	1.3	V

Notes:

- ① Pulse test ; Pulse width ≤ 300μs, duty cycle ≤ 2%.
- ② Pulse width limited by maximum allowable junction temperature.
- ③ Limited by T_{Jmax}, starting T_J = 25°C, L = 0.5mH, R_G = 25Ω, I_{AS} = 7A, V_{GS} = 10V. Part not recommended for use above this value

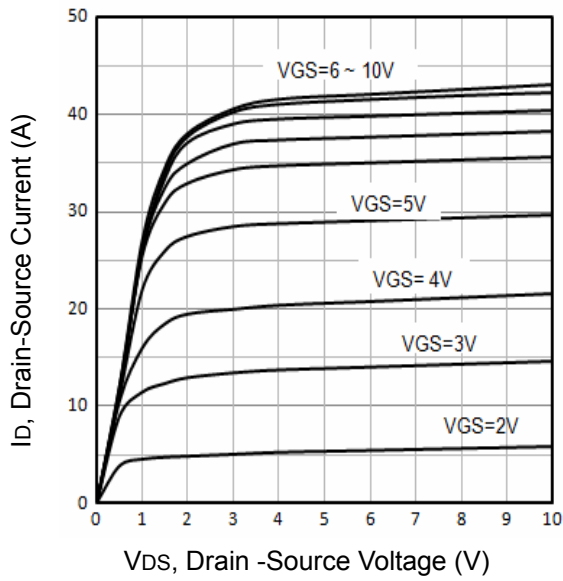


Fig1. Typical Output Characteristics

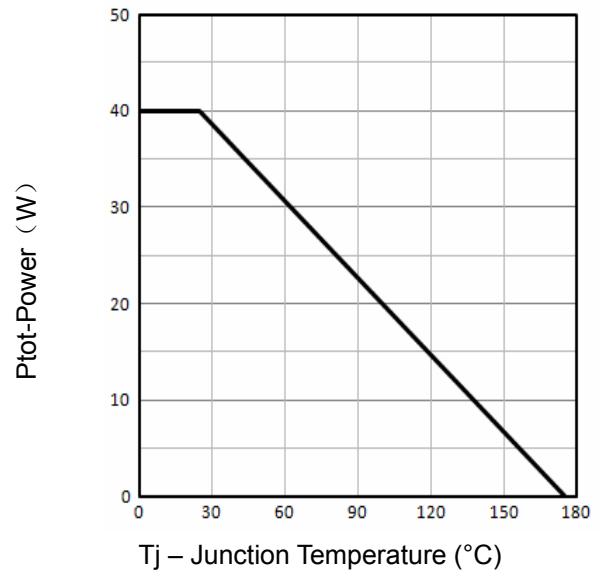


Fig2. Power Dissipation

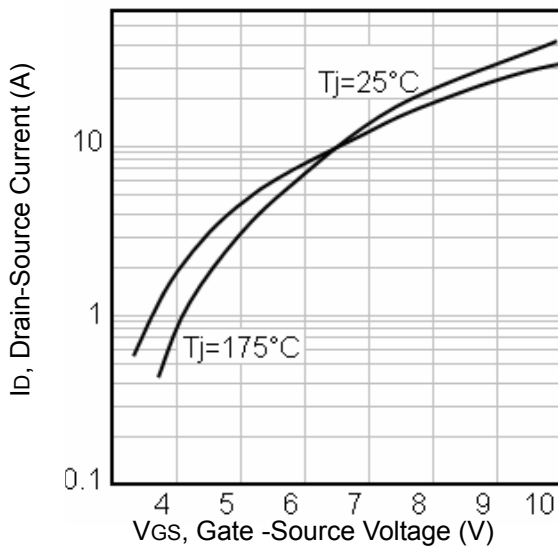


Fig3. Typical Transfer Characteristics

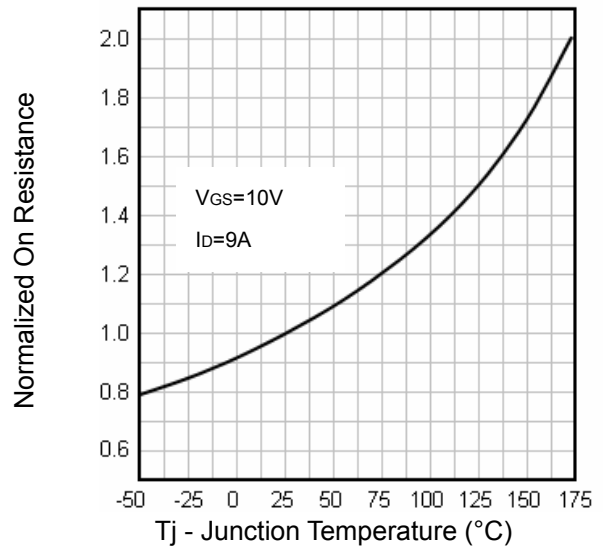


Fig4. Normalized On-Resistance Vs. Temperature

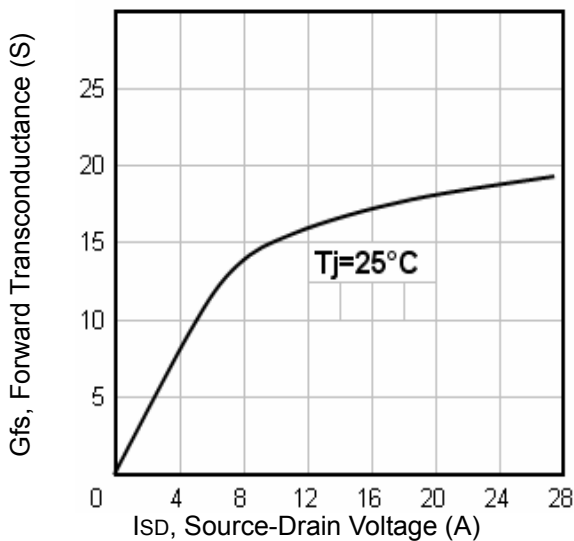


Fig5. Typical Forward Transconductance Vs. Drain Current

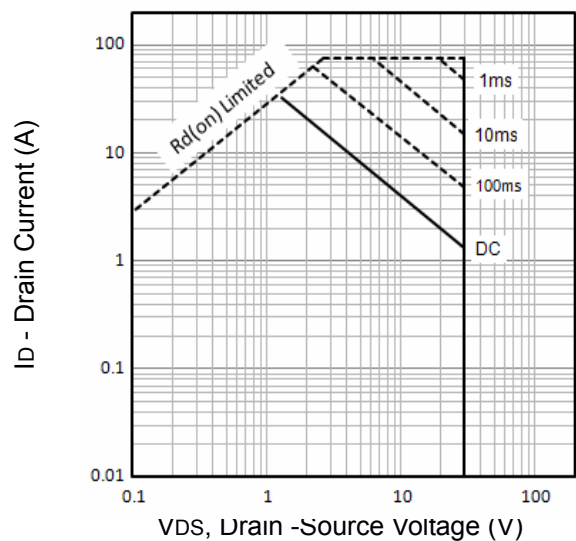


Fig6. Maximum Safe Operating Area

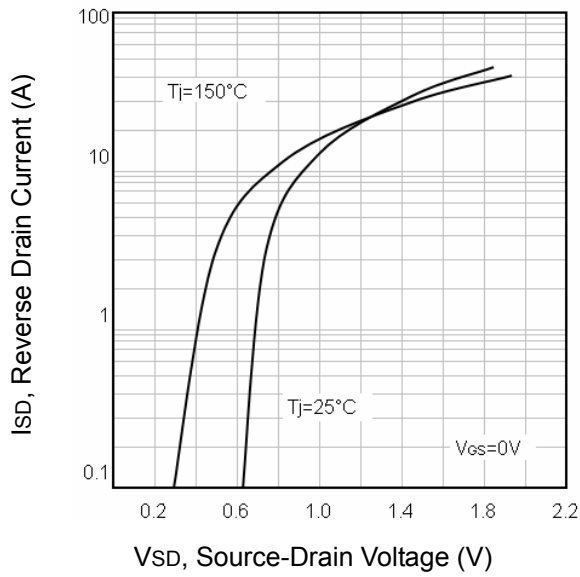


Fig7. Typical Source-Drain Diode Forward Voltage

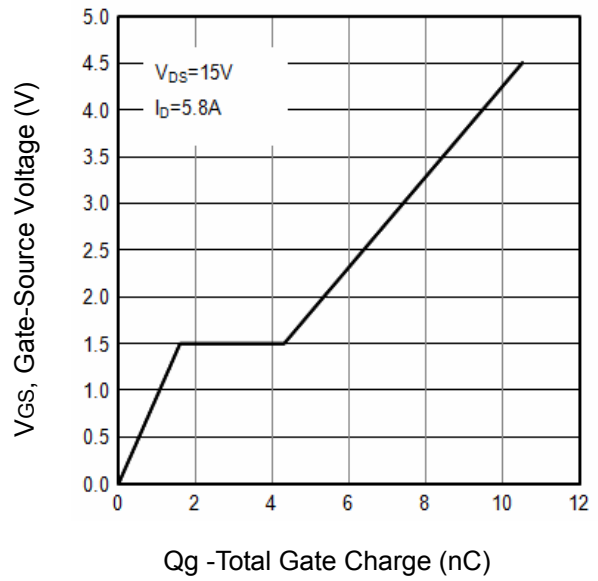


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

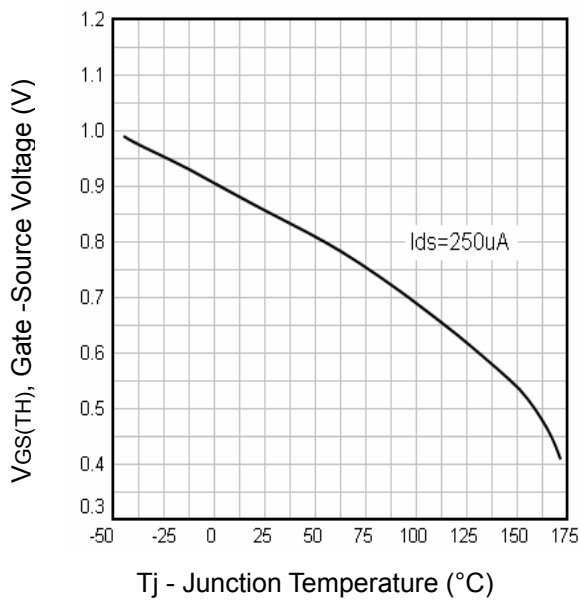


Fig9. Threshold Voltage Vs. Temperature

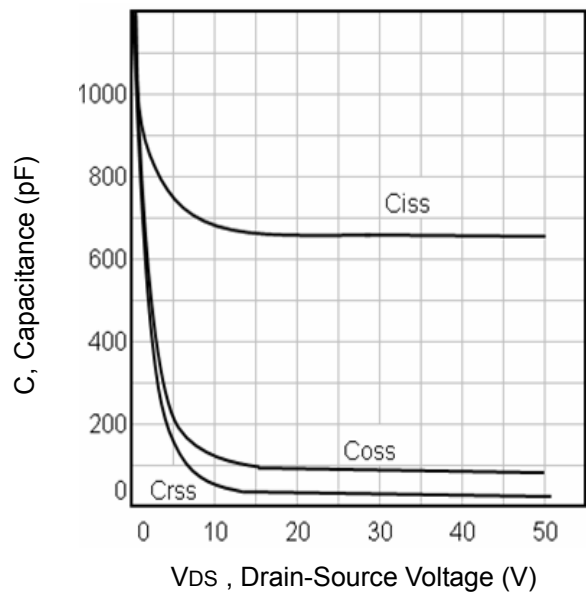


Fig10. Typical Capacitance Vs. Drain-Source Voltage

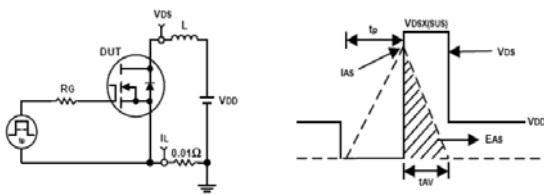


Fig11. Unclamped Inductive Test Circuit and waveforms

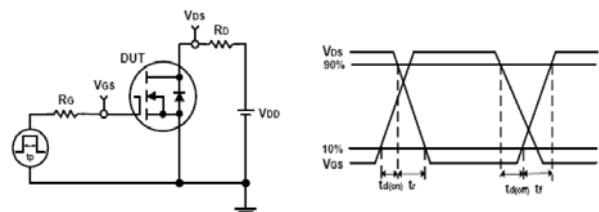
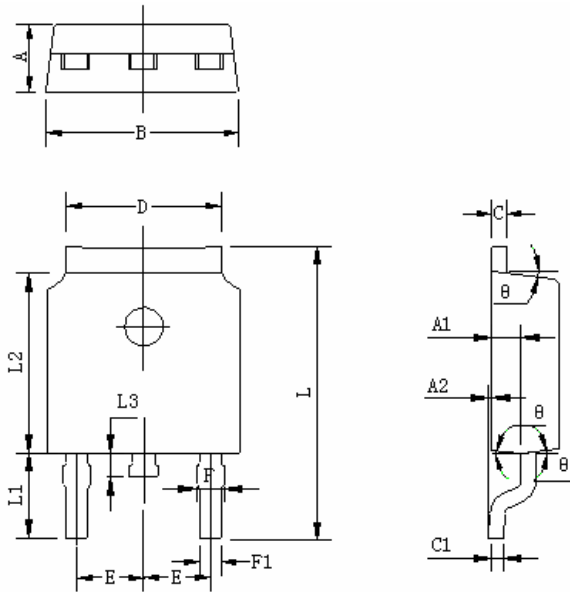


Fig12. Switching Time Test Circuit and waveforms

TO-252 Mechanical Data



Symbol	Dimensions In Millimeters		
	Min	Nom	Max
A	2.25	2.3	2.35
A1	0.96	1.01	1.06
A2	0.05	0.1	0.15
B	6.05	6.6	6.65
C	0.46	0.508	0.580
C1	0.508	0.508	0.508
D	5.31	5.32	5.33
E	2.186	2.286	2.386
F	0.075	0.085	0.095
F1	0.660	0.76	0.860
L	9.80	9.825	10.40
L1	2.9REF		
L2	6.05	6.1	6.15
L3	0.79	0.8	0.81
θ	7°	7°	7°

Order Information

Product	Marking	Package	Packaging	Min Unit Quantity
VS3019AD	VS3019AD	TO-252	2500/Reel	5000

Customer Service

Sales and Service:
Sales@vgsemi.com

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